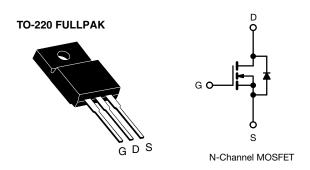
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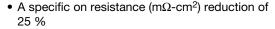
Vishay Siliconix

## **EF Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMARY			
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650		
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	0.084	
Q <sub>g</sub> max. (nC)	134		
Q <sub>gs</sub> (nC)	16		
Q <sub>gd</sub> (nC)	48		
Configuration	Single		

#### **FEATURES**





- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (C<sub>iss</sub>)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qq)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHF35N60EF-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			$V_{DS}$	600	V
Gate-source voltage			$V_{GS}$	± 30	<b>□</b>
Continuous drain current (T,I = 150 °C) e	V at 10 V	$V_{GS}$ at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	- I <sub>D</sub>	32	
Continuous drain current (1) = 150 C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		20	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	80	
Linear derating factor				2.0	W/°C
Single pulse avalanche energy b			E <sub>AS</sub>	298	mJ
Maximum power dissipation			$P_{D}$	39	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope T <sub>J</sub> = 125 °C		dv/dt	100	V/ns	
Reverse diode dv/dt <sup>d</sup>			50	V/11S	
Soldering recommendations (peak temperature) c	For	10 s		260	°C
Mounting torque M3 screw				0.6	Nm

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 4.6 A
- c. 1.6 mm from case
- d.  $I_{SD} = 17$  A, di/dt = 300 A/ $\mu$ s, starting  $T_J = 25$  °C
- e. Limited by maximum junction temperature



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	$R_{thJA}$	-	65	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	3.2	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 10 mA	-	0.66	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
		V <sub>DS</sub> =	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 17 A	-	0.084	0.097	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 17 A	-	8	-	S
Dynamic						•	
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	2568	-	
Output capacitance	C <sub>oss</sub>	,	$V_{DS} = 100 \text{ V},$	-	113	-	1
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz		7	-	1
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$			-	81	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		421	-	
Total gate charge	Qg			-	89	134	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 17 A, V <sub>DS</sub> = 480 V		16	-	nC
Gate-drain charge	Q <sub>gd</sub>	1		-	48	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 17 A,		-	28	56	
Rise time	t <sub>r</sub>			-	85	170	1
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$= 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$	-	96	192	ns
Fall time	t <sub>f</sub>	1		-	61	122	1
Gate input resistance	$R_g$	f = 1	f = 1 MHz, open drain		0.5	1.0	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	32	
Pulsed diode forward current	I <sub>SM</sub>			-	-	80	- A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 17 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>		1,0 25 5,13, 1,03 = 5 1		150	300	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 17 \text{ A},$ $di/dt = 100 \text{ A/µs}, V_R = 400 \text{ V}$		-	1.1	2.2	μC
Reverse recovery current	I <sub>RRM</sub>			_	14	-	Α

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

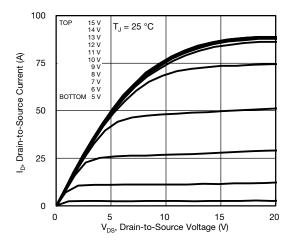


Fig. 1 - Typical Output Characteristics

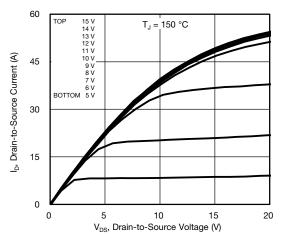


Fig. 2 - Typical Output Characteristics

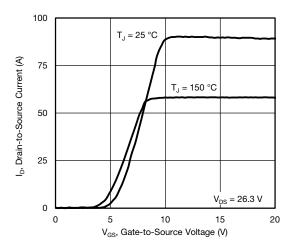


Fig. 3 - Typical Transfer Characteristics

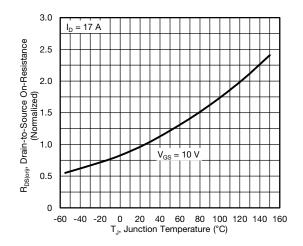


Fig. 4 - Normalized On-Resistance vs. Temperature

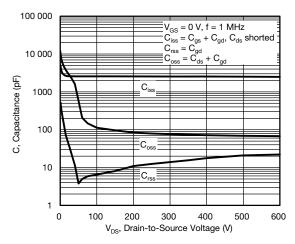


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

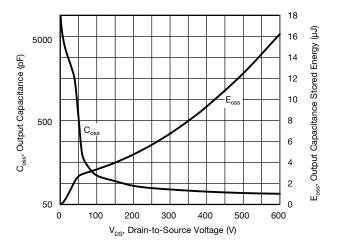


Fig. 6 - Coss and Eoss vs. VDS



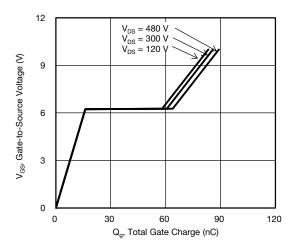


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

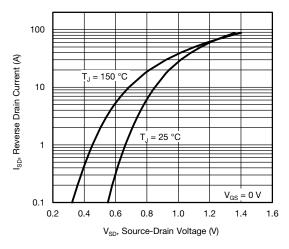


Fig. 8 - Typical Source-Drain Diode Forward Voltage

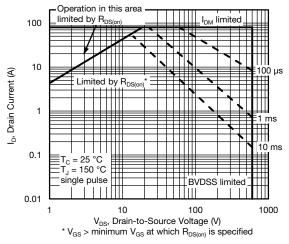


Fig. 9 - Maximum Safe Operating Area

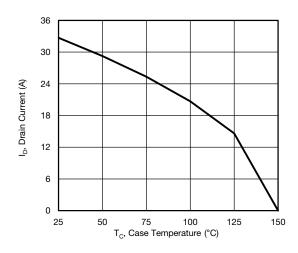


Fig. 10 - Maximum Drain Current vs. Case Temperature

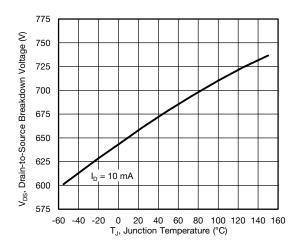


Fig. 11 - Temperature vs. Drain-to-Source Voltage



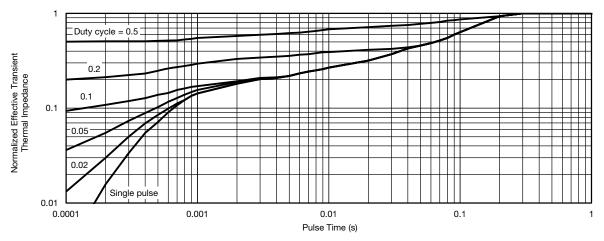


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

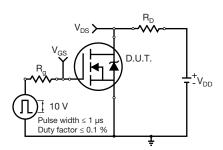


Fig. 13 - Switching Time Test Circuit

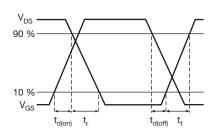


Fig. 14 - Switching Time Waveforms

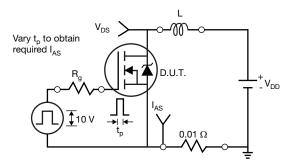


Fig. 15 - Unclamped Inductive Test Circuit

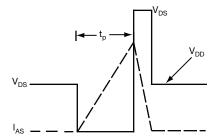


Fig. 16 - Unclamped Inductive Waveforms

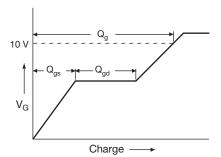


Fig. 17 - Basic Gate Charge Waveform

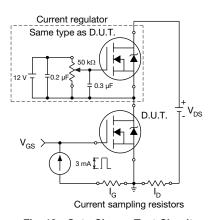


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dv/dt Test Circuit

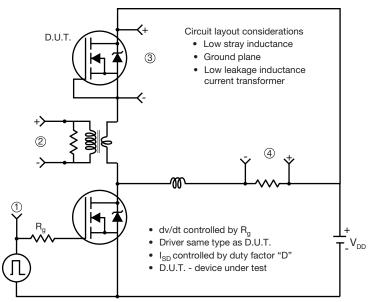




Fig. 19 - For N-Channel

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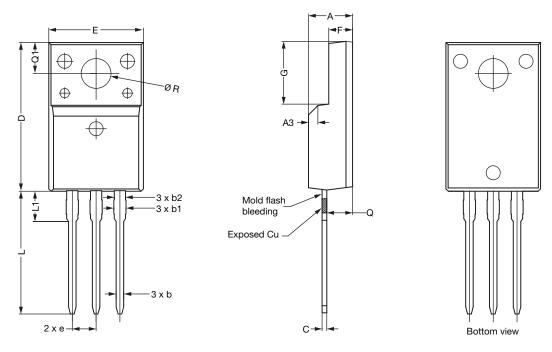
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Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?92110">www.vishay.com/ppg?92110</a>.

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# **TO-220 FULLPAK (High Voltage)**

### **OPTION 1: FACILITY CODE = 9**

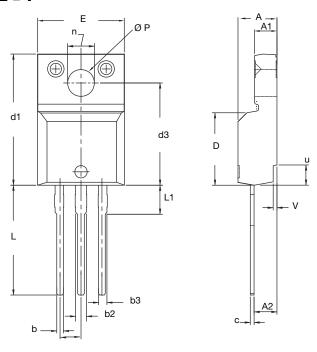


	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
A	4.60	4.70	4.80	
b	0.70	0.80	0.91	
b1	1.20	1.30	1.47	
b2	1.10	1.20	1.30	
С	0.45	0.50	0.63	
D	15.80	15.87	15.97	
е	2.54 BSC			
E	10.00	10.10	10.30	
F	2.44	2.54	2.64	
G	6.50	6.70	6.90	
L	12.90	13.10	13.30	
L1	3.13	3.23	3.33	
Q	2.65	2.75	2.85	
Q1	3.20	3.30	3.40	
ØR	3.08	3.18	3.28	

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



### **OPTION 2: FACILITY CODE = Y**



	MILLIMETERS		INCI	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
Е	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	
ECN: E10 0190 Pov D (	00 Apr 2010	•			

ECN: E19-0180-Rev. D, 08-Apr-2019

DWG: 5972

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- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



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